



University of San Carlos | Department of
COMPUTER ENGINEERING

CpE 3202
Computer Organization & Architecture

Computer Memory (Internal)

Characteristics of Computer Memory Systems

- Location
- Capacity
- Unit of transfer
- Access method
- Performance
- Physical type
- Physical characteristics
- Organization

Location

- **CPU**
 - Registers and L1 cache
- **Internal**
 - Main
- **External**
 - Secondary

Capacity

- **Word size**
 - The natural unit of organization
 - Typically equal to the number of bits used to represent a number and to the instruction length
- **Number of words**
 - Or bytes
 - Has to do with the number of addressable units

Unit of Transfer

- **Internal**
 - Usually governed by data bus width
- **External**
 - Usually a block which is much larger than a word
- **Addressable unit**
 - Smallest location which can be uniquely addressed
 - Word internally
 - Cluster on M\$ disks

Access Methods (1)

- **Sequential Access**
 - Start at the beginning and read through in order
 - Access time is highly variable – *depends on location of data and previous access*
 - e.g. tape
- **Direct Access**
 - Individual blocks have unique addresses based on physical location
 - Access is direct by jumping to vicinity plus sequential search
 - Access time is still variable – *but not as much as sequential*
 - *depends on location of data and previous access*
 - e.g. disk

Access Methods (2)

- **Random Access**
 - Individual addresses identify physical locations exactly
 - Access is direct to desired location
 - Access time is independent of location or previous access
 - e.g. RAM
- **Associative**
 - Data is retrieved by comparing a sub-part of the data with a desired mask (*location is not needed*)
 - All matches to the mask are retrieved simultaneously
 - Access time is independent of location or previous access
 - e.g. cache

Memory Hierarchy

- **Registers**
 - In CPU
- **Internal or Main memory**
 - May include one or more levels of cache
 - “RAM”
- **External memory**
 - Backing store

Performance

- **Access time**
 - Time between presenting the address and getting the valid data
- **Memory Cycle time**
 - Time may be required for the memory to “recover” before next access
 - ***Cycle time*** is access + recovery
- **Transfer Rate**
 - Rate at which data can be moved (bits/sec)

Physical Types

- **Semiconductor**
 - RAM
- **Magnetic**
 - Disk & Tape
- **Optical**
 - CD & DVD
- **Others**
 - Bubble (*stationary disk with spinning bits*)
 - Hologram (*optical, will go beneath the surface and use the volume of the recording medium for storage*)

Physical Characteristics

- **Decay**
- **Volatility**
 - Volatile (*information is lost without power*)
 - Non-volatile (*information retains until changed; no electrical power needed*)
- **Erasable**
 - Erasable
 - Non-erasable (*information can't be altered with a normal memory access cycle; must be non-volatile*)
- **Power consumption**

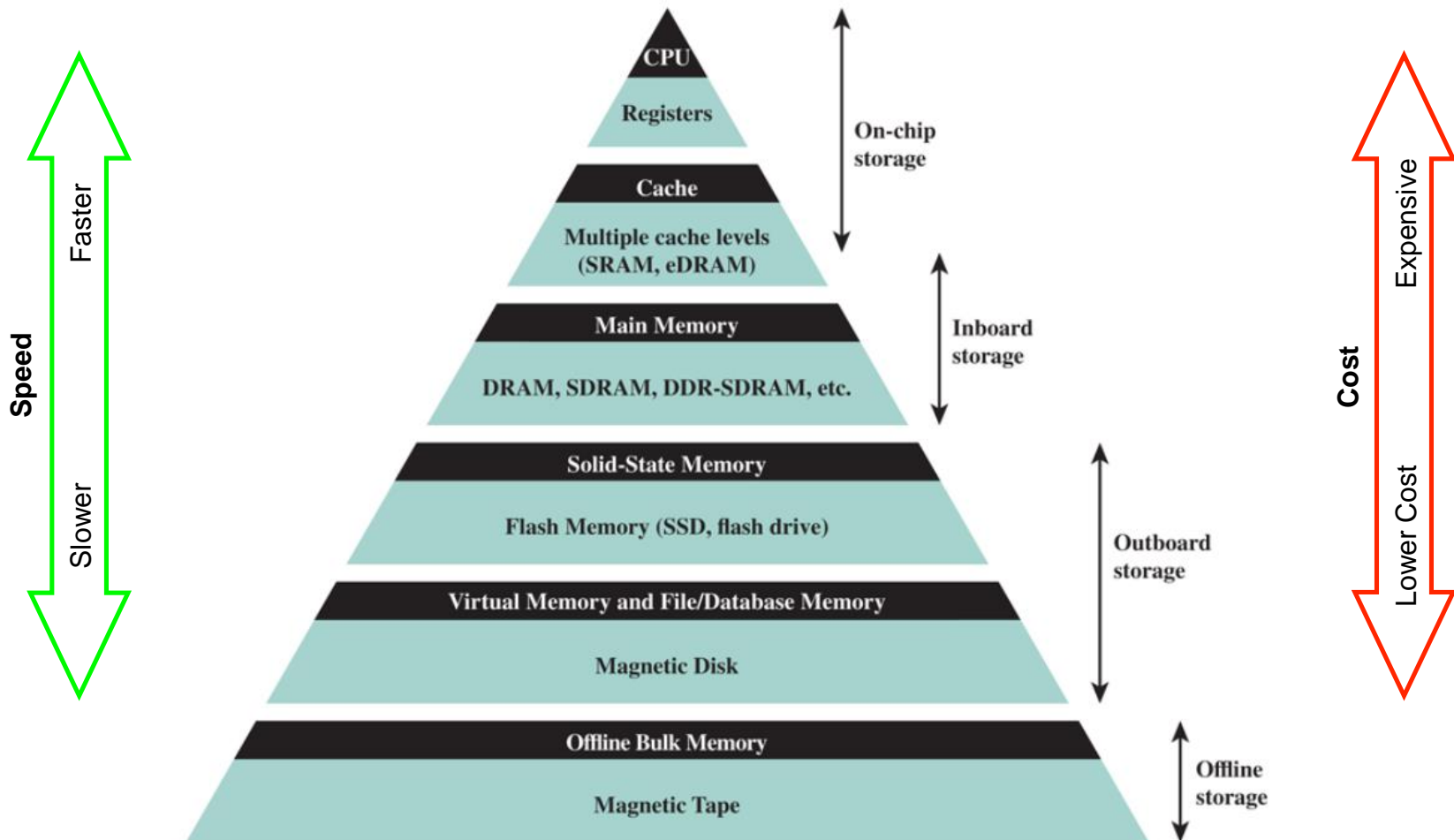
Organization

- Physical arrangement of bits into words
- Not always obvious
- e.g. interleaved organization, characters vs. integers vs. floating point numbers

The Bottom Line: Design Constraints

- **How much?**
 - Capacity
 - Applications tend to be built to use any commonly available amount
- **How fast?**
 - Time is money
 - Must be able to keep up with the CPU
- **How expensive?**
 - Cost must be reasonable

Hierarchy List



So you want fast?

- It is possible to build a computer which uses only static RAM (*see later*)
- This would be very fast
- This would need no cache
 - How can you cache cache?
- This would cost a very large amount

Locality of Reference

- Success depends upon the **locality of reference**
- During the course of the execution of a program, **memory references tend to cluster** (e.g. loops)
- **Temporal locality**
 - If a location is referenced, it is likely to be referenced again in the near future
- **Positional locality**
 - Time is money
- Basis for caching and virtual memory

Semiconductor Memory

- **RAM**
 - Misnamed as all semiconductor memory is random access
 - Read/Write
 - Volatile
 - Temporary storage
 - Static or Dynamic

Dynamic RAM

- Bits stored as charge in capacitors
- Charges leak
- Need refreshing even when powered
- Simpler construction
- Smaller per bit
- Less expensive
- Need refresh circuits
- Slower
- Main memory



DRAMs in SODIMM Form Factor

Static RAM

- Bits stored as on/off switches
- No charges to leak
- No refreshing needed when powered
- More complex construction
- Larger per bit
- More expensive
- Does not need refresh circuits
- Faster
- Cache



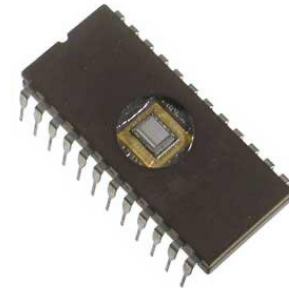
SRAM in an SOIC Package

Read Only Memory (ROM)

- Permanent storage
- Microprogramming (*see later*)
- Library subroutines
- Systems programs (BIOS)
- Function tables

Types of ROM

- Written during manufacture
 - Very expensive for small runs
- **Programmable (once) - PROM**
 - Needs special equipment to program
- **Read “mostly”**
 - **Erasable Programmable (EPROM)**
 - Erased by UV
 - **Electrically Erasable (EEPROM)**
 - Byte-level writing
 - Takes much longer to write than read
 - **Flash memory**
 - Erase whole memory electrically



EPROM in DIP Package



Flash memory in Quad-Flat Package

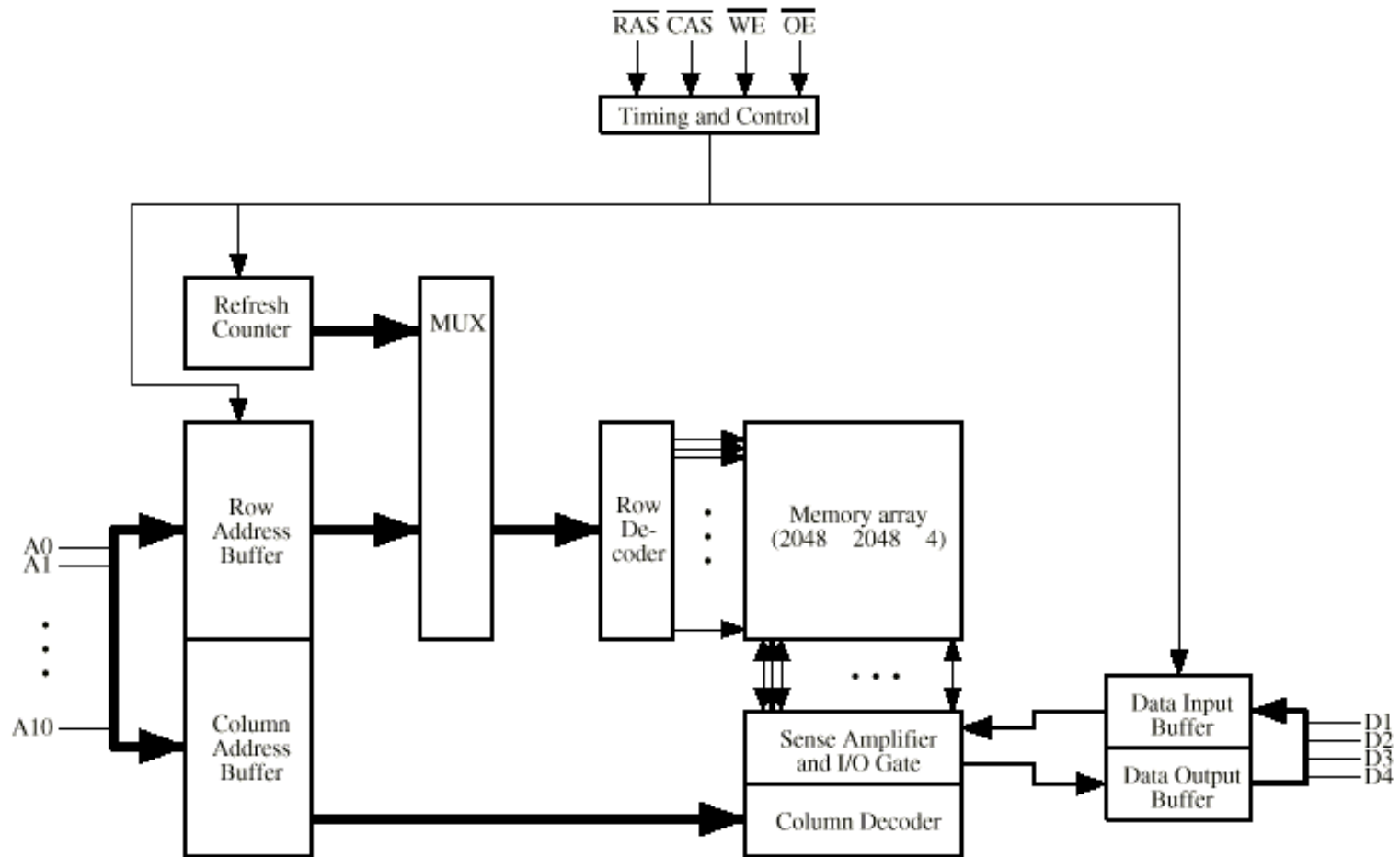
Organization in detail

- A 16Mbit chip can be organized as 1M of 16 bit words
- A bit per chip system has 16 lots of 1Mbit chip with bit 1 of each word in chip 1 and so on
- A 16Mbit chip can be organized as a 2048 x 2048 x 4bit array
 - Reduces number of address pins
 - Multiplex row address and column address
 - 11 pins to address ($2^{11}=2048$)
 - Adding one more pin doubles range of values

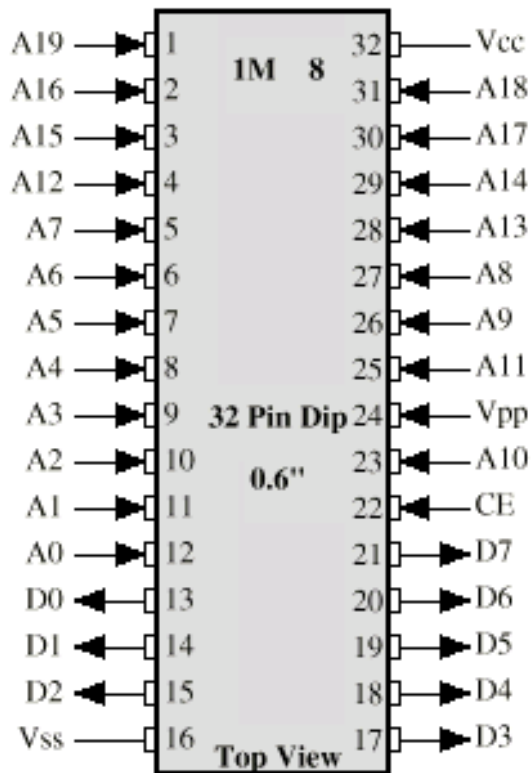
Refreshing

- Refresh circuit included on chip
- Disable chip
- Count through rows
- Read & Write back
- Takes time
- Slows down apparent performance

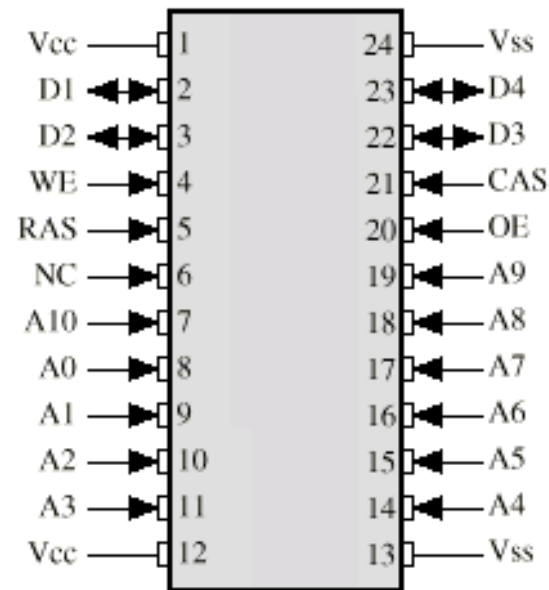
Typical 16 Mb DRAM (4M x 4)



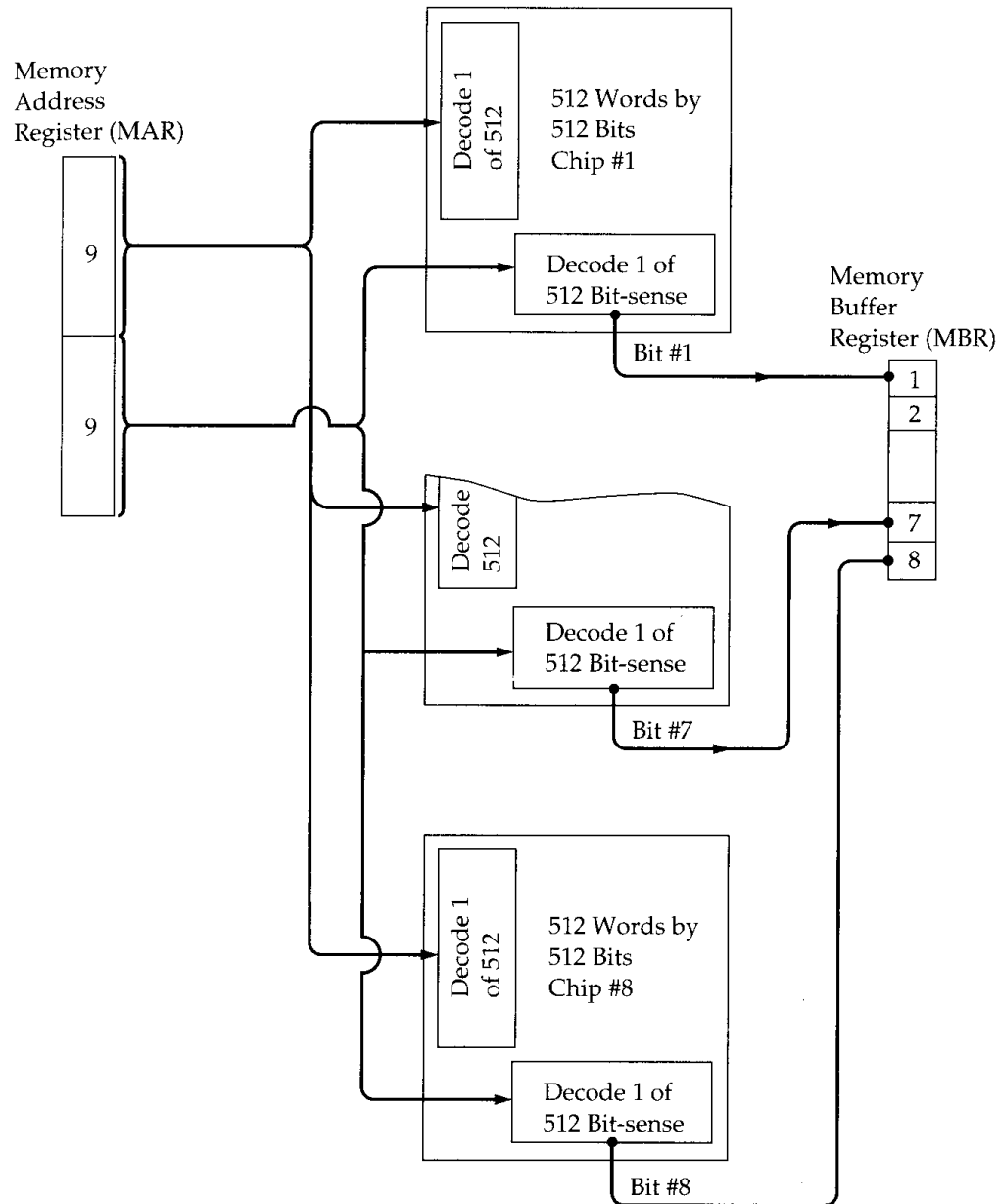
Packaging



(a) 8 Mbit EPROM

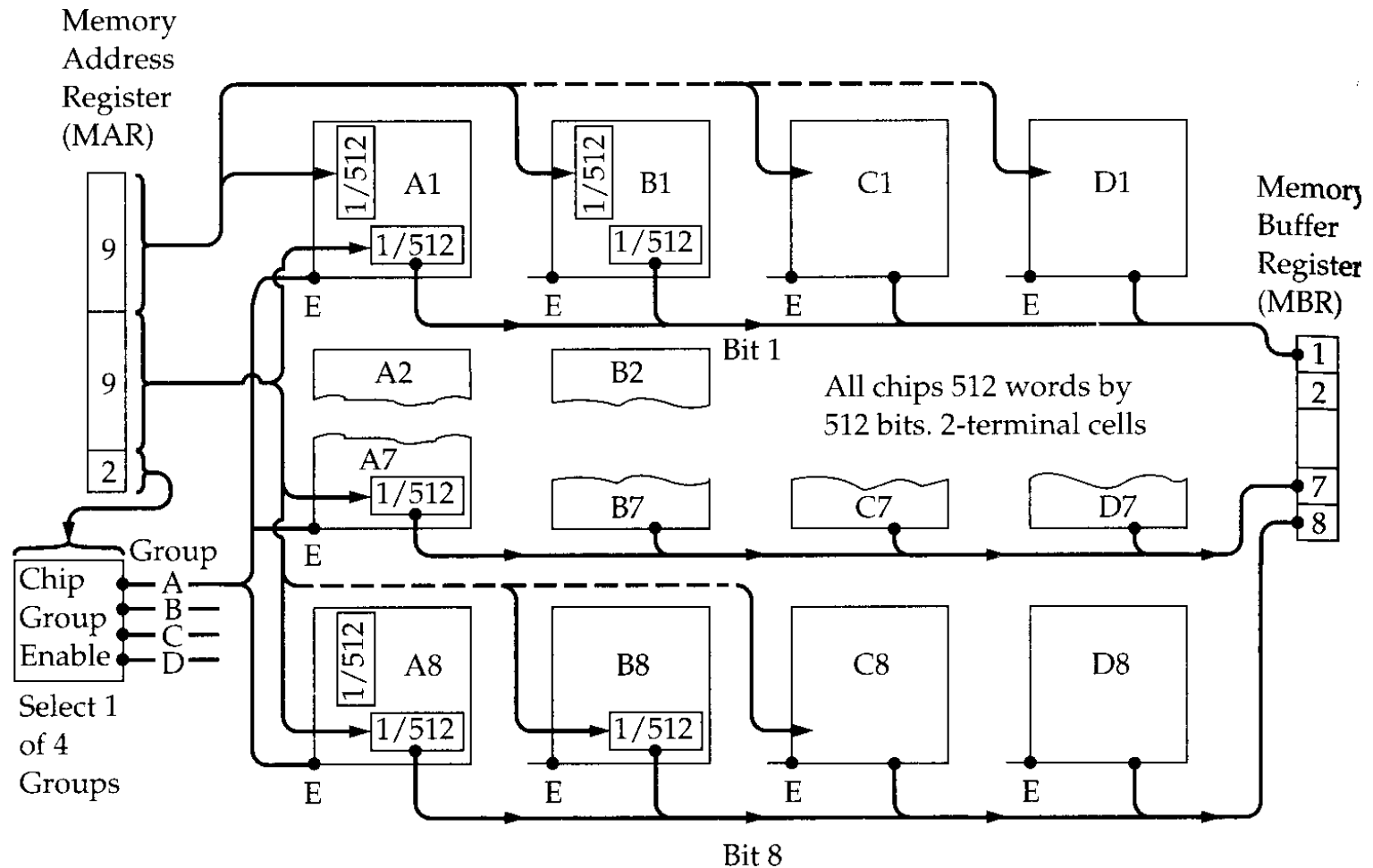


(b) 16 Mbit DRAM



Module
organization

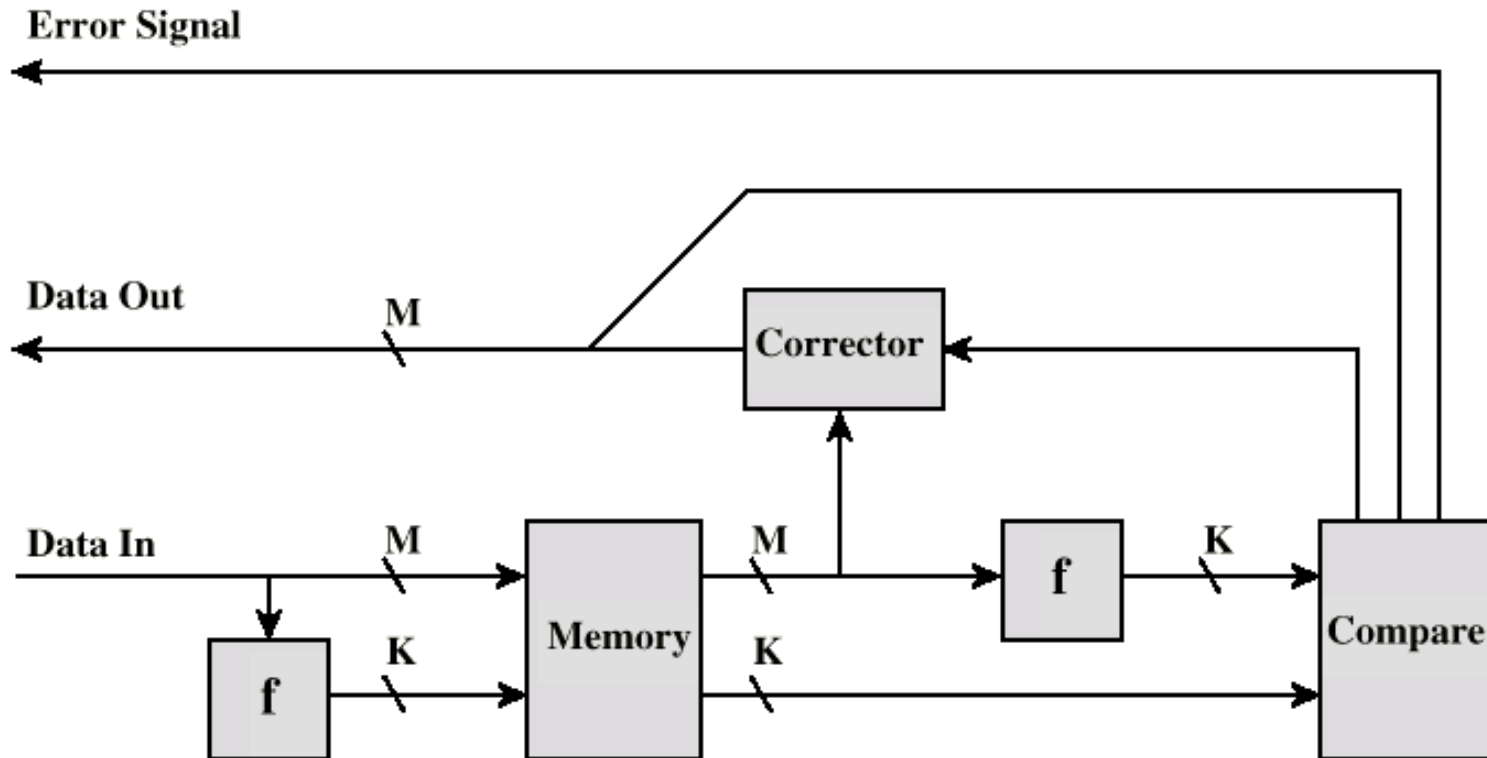
Module organization (2)



Error Correction

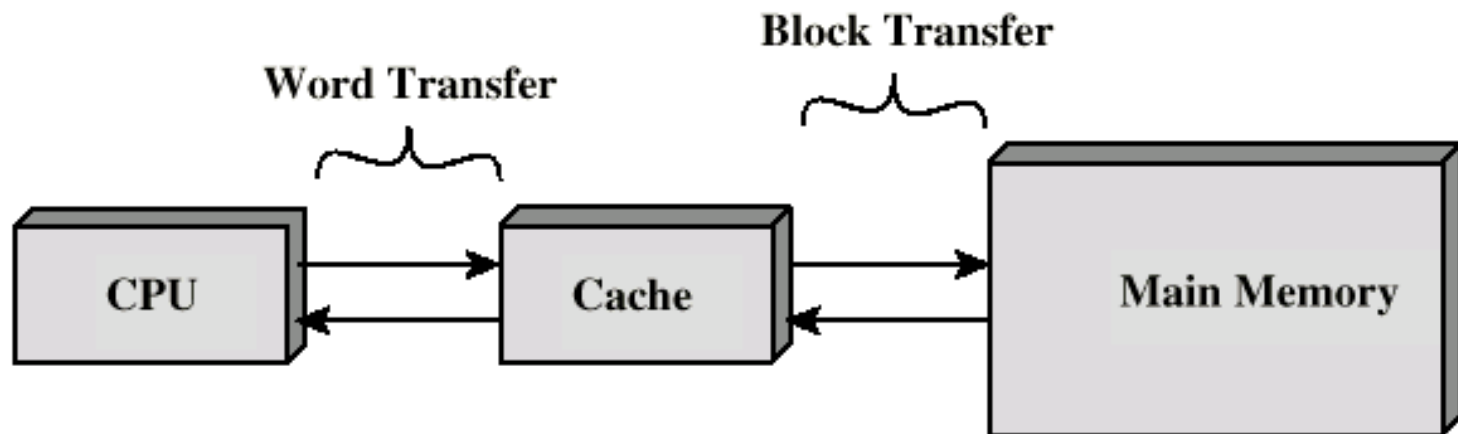
- **Hard Failure**
 - Permanent defect
- **Soft Error**
 - Random, non-destructive
 - No permanent damage to memory
 - Caused by power supply problems, alpha particles
- **Detection and Correction**
 - Hamming error correcting code
 - SEC-DED codes

Error Correcting Code Function



Cache

- Small amount of fast memory
- Sits between normal main memory and CPU
- May be located on CPU chip or module



Cache operation - overview

- CPU requests contents of memory location
- Check cache for this data
- If present, get from cache (fast)
- If not present, read required block from main memory to cache
- Then deliver from cache to CPU
- Cache includes **tags** to identify which block of main memory is in each cache slot
- The proportion of memory references, which are found already stored in cache, is called the **hit ratio**.

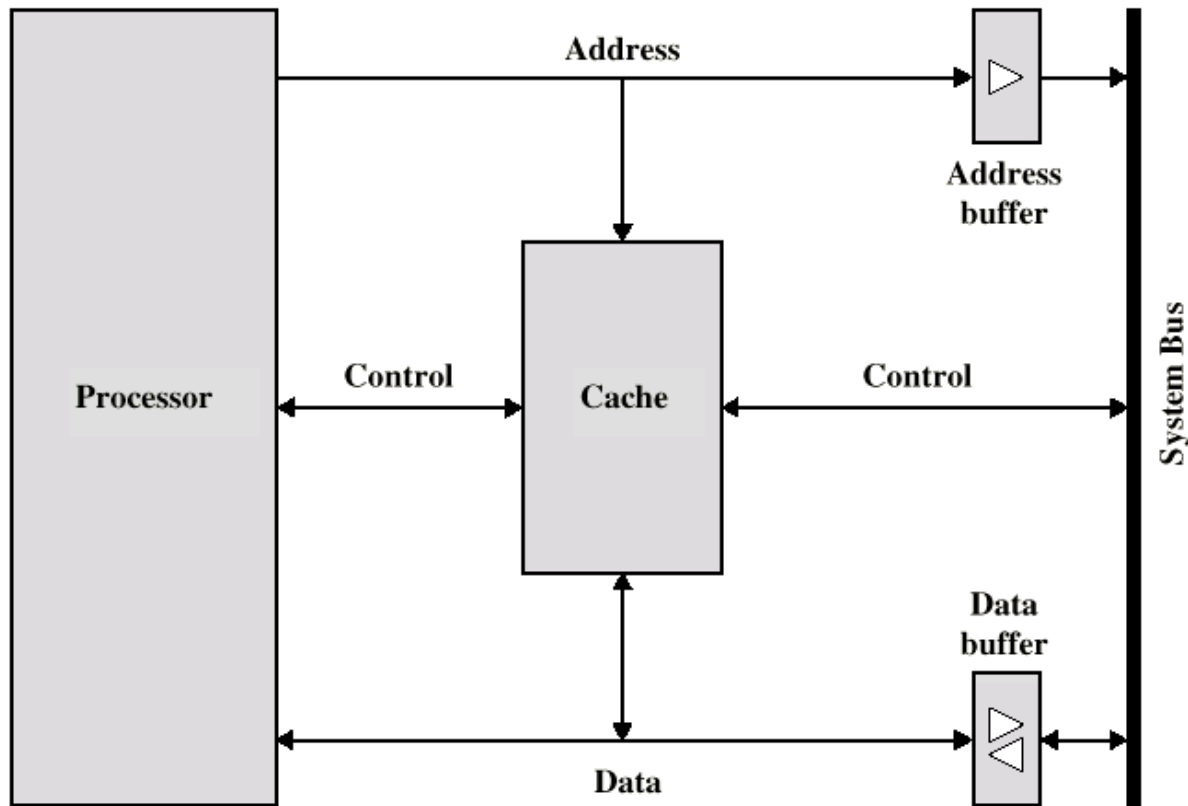
Elements of Cache Design

- Size
- Mapping Function
- Replacement Algorithm
- Write Policy
- Block Size
- Number of Caches

Size does matter

- **Cost**
 - More cache is expensive
- **Speed**
 - More cache is faster (up to a point)
 - Checking cache for data takes time

Typical Cache Organization



Mapping Function

- Determines which cache line to use for a particular block of main memory (*since $number_of_cache_lines \ll number_of_blocks$*)
- Cache of 64kByte
- Cache block of 4 bytes
 - i.e. cache is 16k (2^{14}) lines of 4 bytes
- 16MBytes main memory
- 24 bit address
 - ($2^{24}=16M$)

Direct Mapping

- Each block of main memory maps to only one cache line
 - i.e. if a block is in cache, it must be in one specific place
- **Address** is in two parts
- Least Significant w bits identify **unique word**
- Most Significant s bits specify **one memory block**
- The MSBs are split into a cache line field r and a tag of $s-r$ (most significant)

Direct Mapping Address Structure

Tag s-r	Line or Slot r	Word w
8	14	2

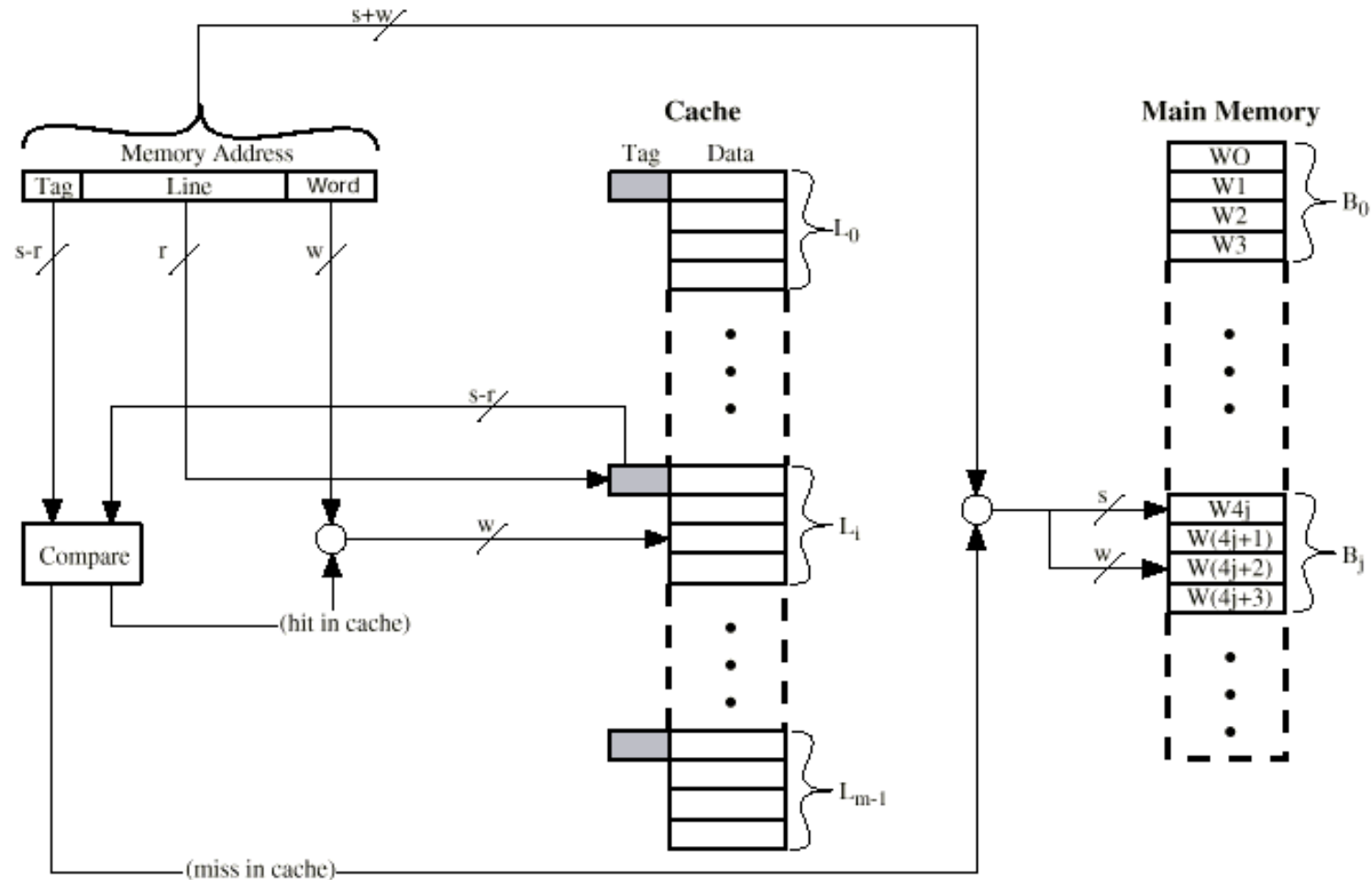
- 24 bit address
- 2 bit word identifier (4 byte block)
- 22 bit block identifier
 - 8 bit tag (=22-14)
 - 14 bit slot or line
- No two blocks in the same line have the same Tag field
- Check contents of cache by finding line and checking Tag

Direct Mapping Cache Line Table

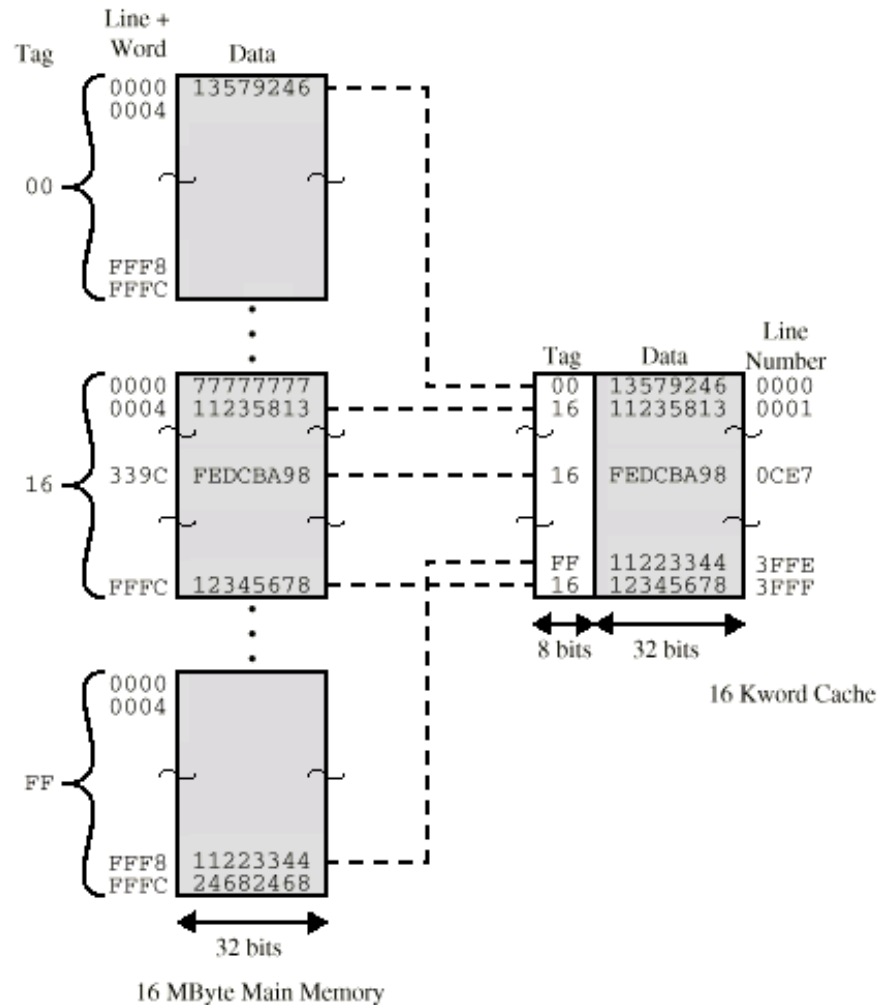
- Cache line Main Memory blocks held
- 0 0, m, 2m, 3m... $2^s - m$
- 1 1, m+1, 2m+1... $2^s - m + 1$

- m-1 m-1, 2m-1, 3m-1... $2^s - 1$

Direct Mapping Cache Organization



Direct Mapping Example



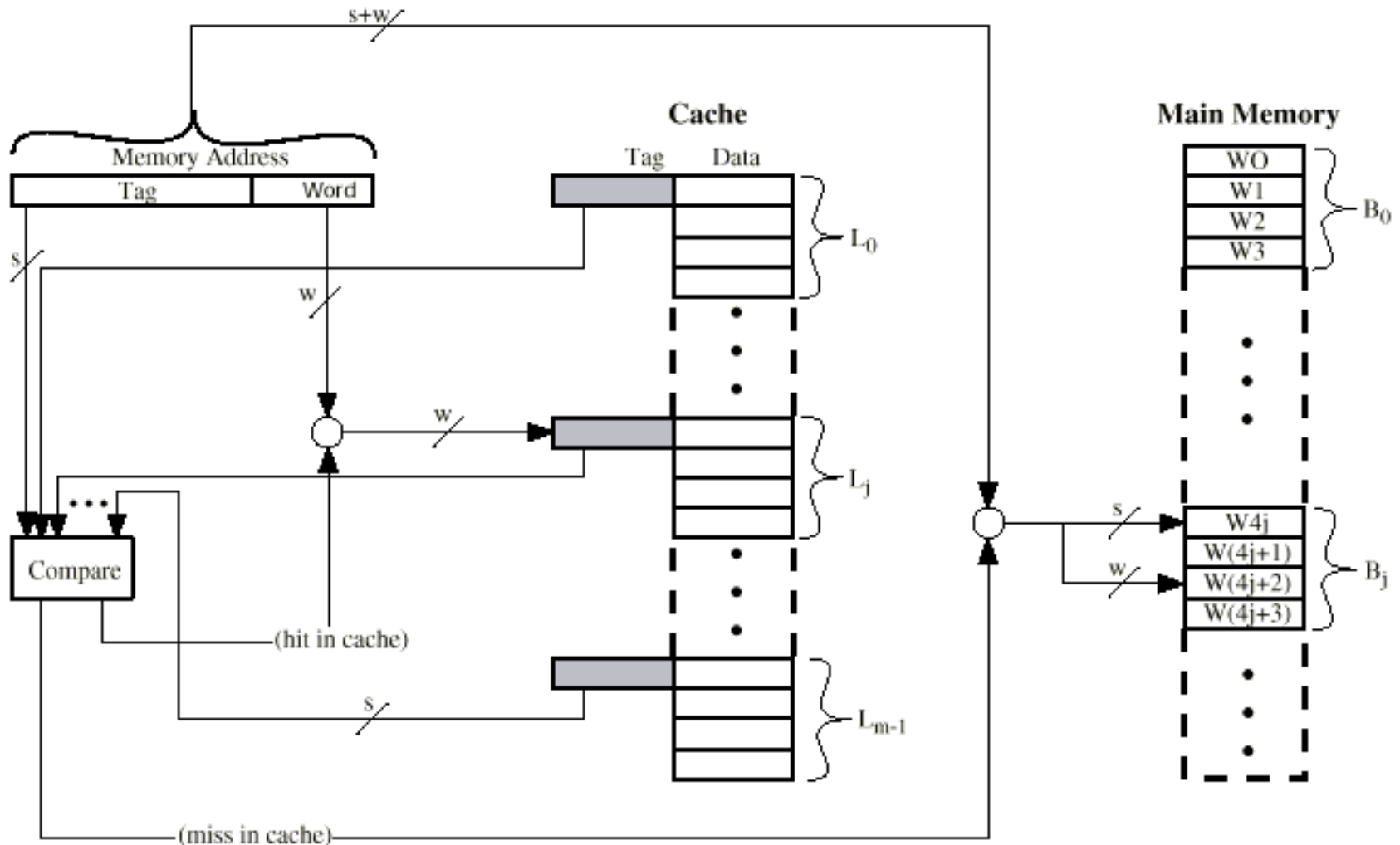
Direct Mapping pros & cons

- Simple
- Inexpensive
- Fixed location for given block
 - If a program accesses 2 blocks that map to the same line repeatedly, cache misses are very high

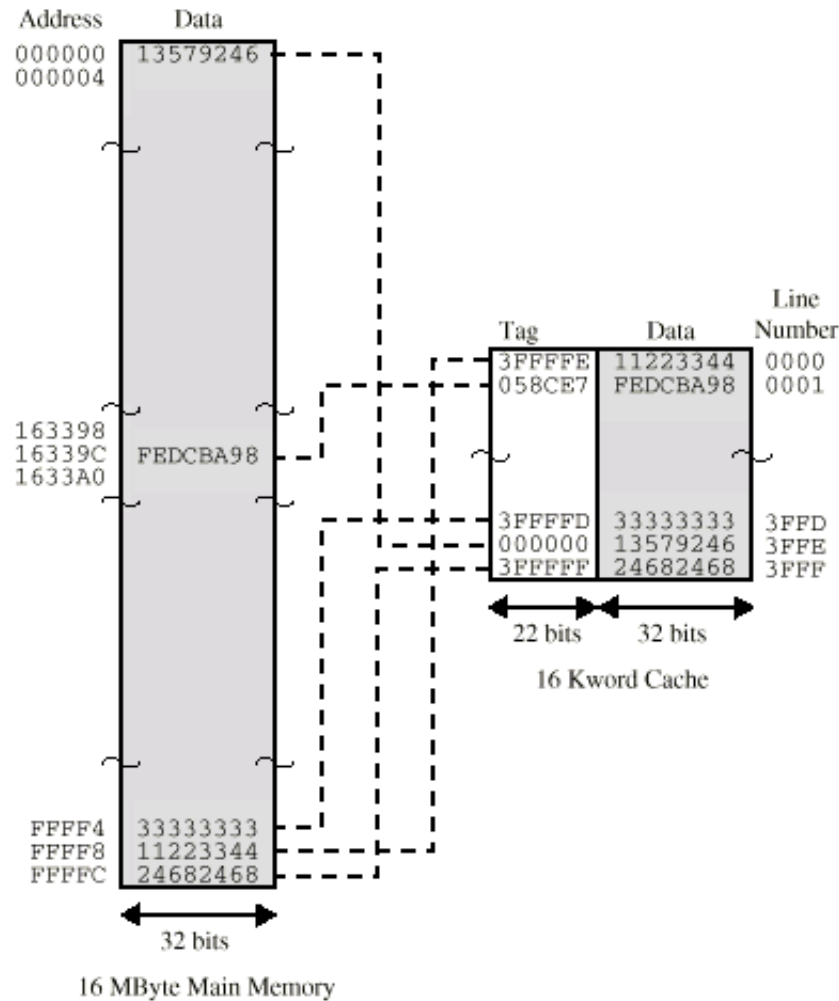
Associative Mapping

- A main memory block can load into any line of cache
- Memory address is interpreted as tag and word
- Tag uniquely identifies block of memory
- Every line's tag is examined for a match
- Cache searching gets expensive

Fully Associative Cache Organization



Associative Mapping Example



Associative Mapping Address Structure

Tag 22 bit	Word 2 bit
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- 22 bit tag stored with each 32 bit block of data
- Compare tag field with tag entry in cache to check for hit
- Least significant 2 bits of address identify which 16 bit word is required from 32 bit data block
- e.g.

Address	Tag	Data	Cache line
FFFFFC	FFFFFC	24682468	3FFF

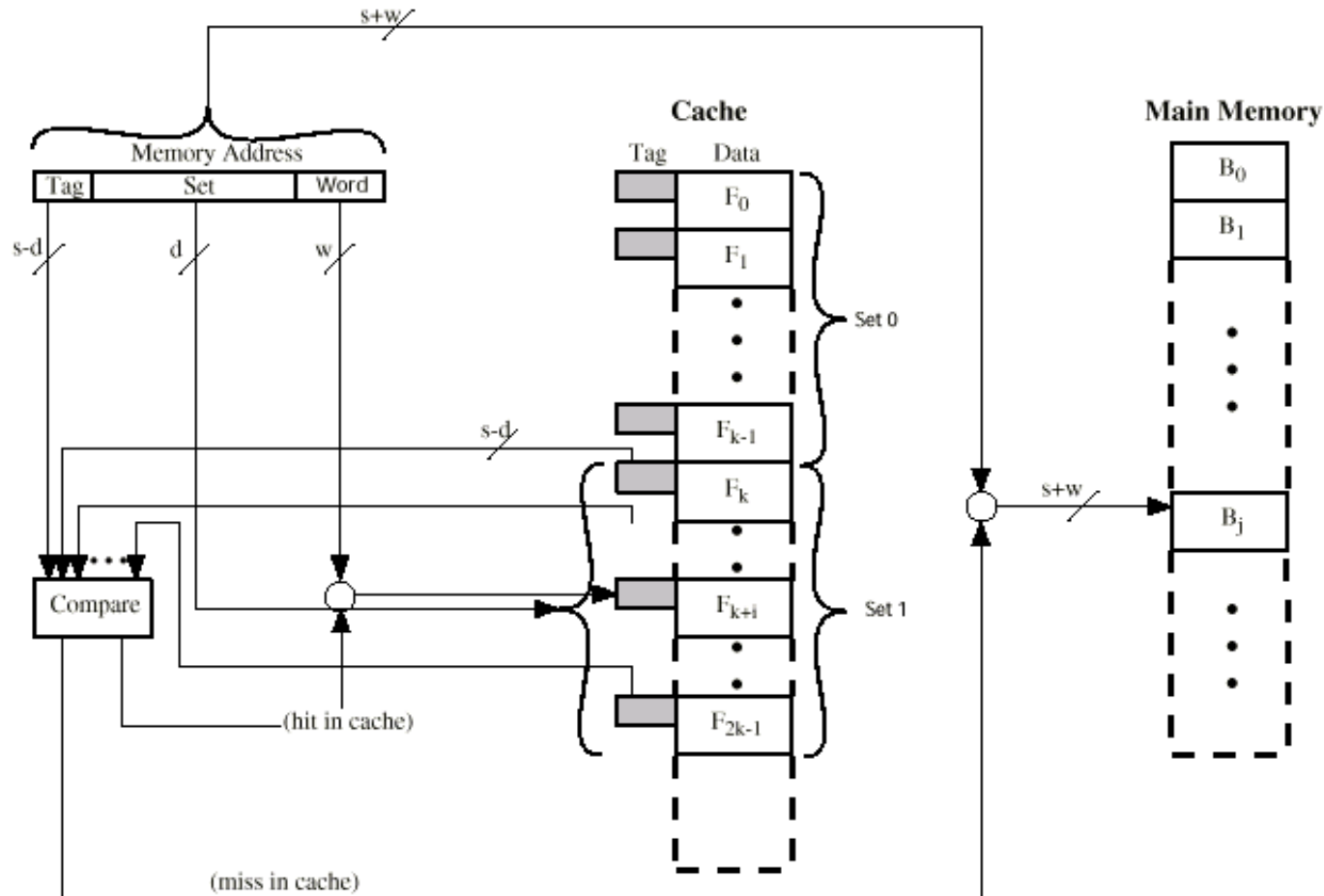
Set Associative Mapping

- Cache is divided into a number of sets
- Each set contains a number of lines
- A given block maps to any line in a given set
 - e.g. Block B can be in any line of set i
- e.g. 2 lines per set
 - 2 way associative mapping
 - A given block can be in one of 2 lines in only one set

Set Associative Mapping Example

- 13 bit set number
- Block number in main memory is modulo 2^{13}
- 000000, 00A000, 00B000, 00C000 ... map to same set

Two Way Set Associative Cache Organization

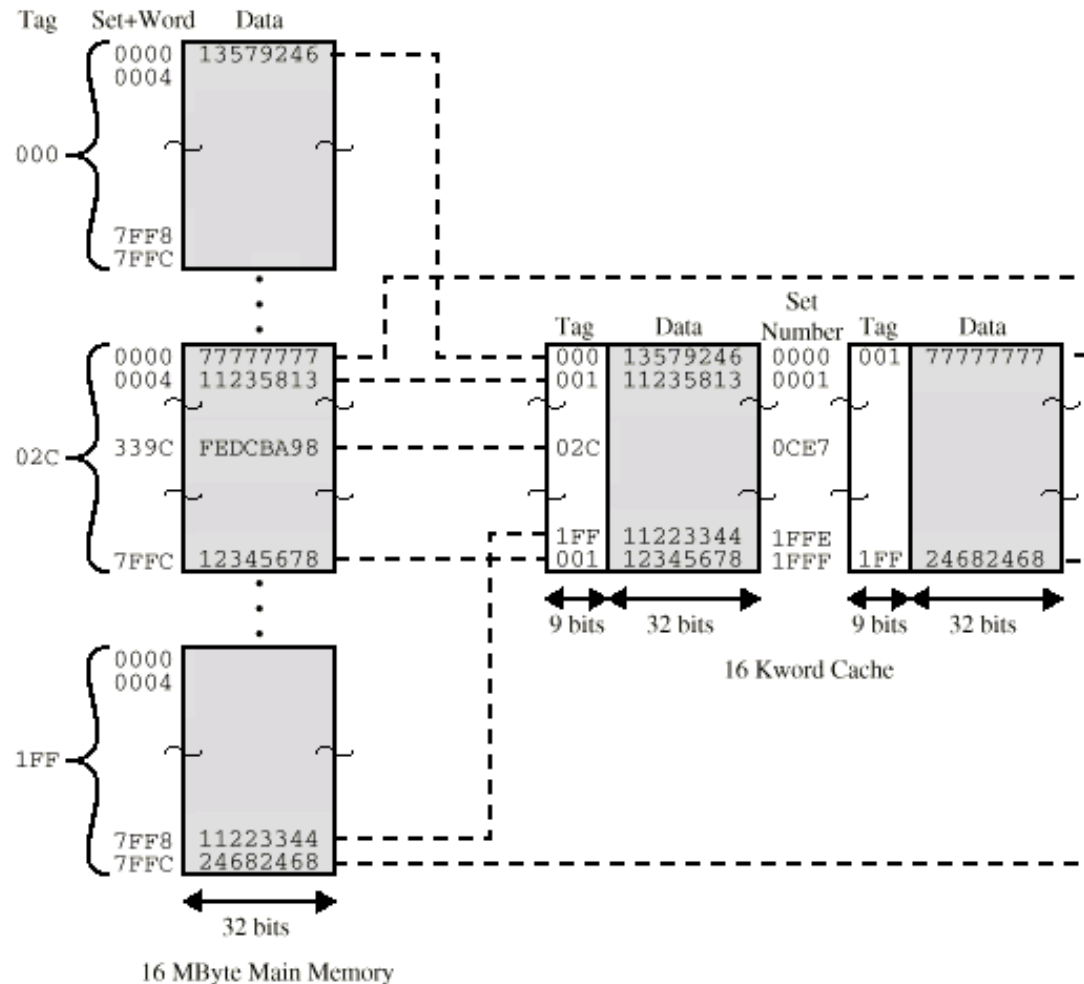


Set Associative Mapping Address Structure

Tag 9 bit	Set 13 bit	Word 2 bit
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- Use set field to determine cache set to look in
- Compare tag field to see if we have a hit
- e.g
 - Address Tag Data Set number
 - 1FF 7FFC 1FF 123456781FFF
 - 001 7FFC 001 112233441FFF

Two Way Set Associative Mapping Example



Replacement Algorithms (1)

Direct mapping

- No choice
- Each block only maps to one line
- Replace that line

Replacement Algorithms (2)

Associative & Set Associative

- Hardware implemented algorithms (speed)
- **Least Recently used (LRU)**
- e.g. in 2 way set associative
 - Which of the 2 block is LRU?
- **First in first out (FIFO)**
 - replace block that has been in cache longest
- **Least frequently used**
 - replace block which has had fewest hits
- **Random**

Write Policy

- Must not overwrite a cache block unless main memory is up to date
- Multiple CPUs may have individual caches
- I/O may address main memory directly

Write through

- All writes go to main memory as well as cache
- Multiple CPUs can monitor main memory traffic to keep local (to CPU) cache up to date
- Lots of traffic
- Slows down writes
- Generates substantial memory traffic and may create a bottleneck

Write back

- Updates initially made in cache only
- Update bit for cache slot is set when update occurs
- If block is to be replaced, write to main memory only if update bit is set
- Other caches get out of sync
- I/O must access main memory through cache
- N.B. 15% of memory references are writes

Pentium Cache

- Foreground reading
- Find out detail of Pentium II cache systems
- NOT just from Stallings!

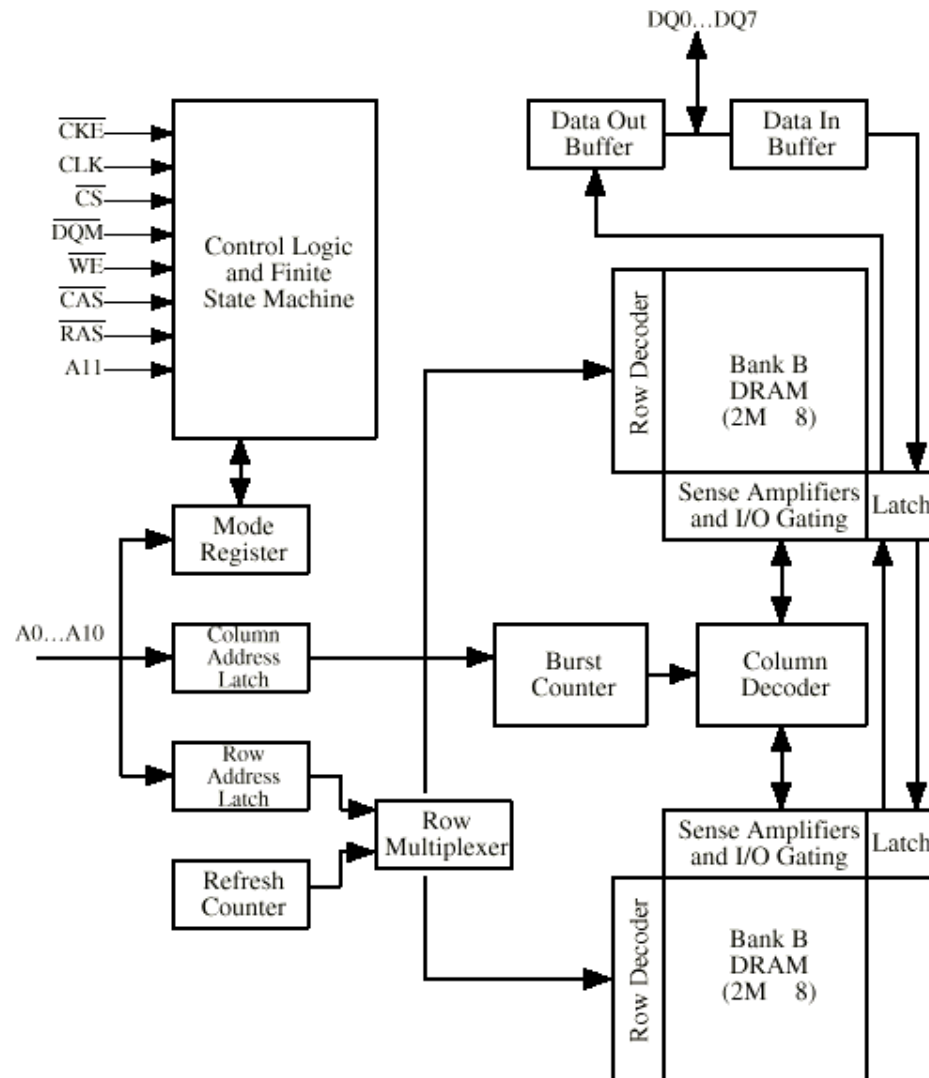
New RAM Technology (1)

- **Basic DRAM** same since first RAM chips
- **Enhanced DRAM**
 - Contains small SRAM as well
 - SRAM holds last line read (c.f. Cache!)
- **Cache DRAM**
 - Larger SRAM component
 - Use as cache or serial buffer

New RAM Technology (2)

- **Synchronous DRAM (SDRAM)**
 - currently on DIMMs
 - Access is synchronized with an external clock
 - Address is presented to RAM
 - RAM finds data (CPU waits in conventional DRAM)
 - Since SDRAM moves data in time with system clock, CPU knows when data will be ready
 - CPU does not have to wait, it can do something else
 - Burst mode allows SDRAM to set up stream of data and fire it out in block

SDRAM

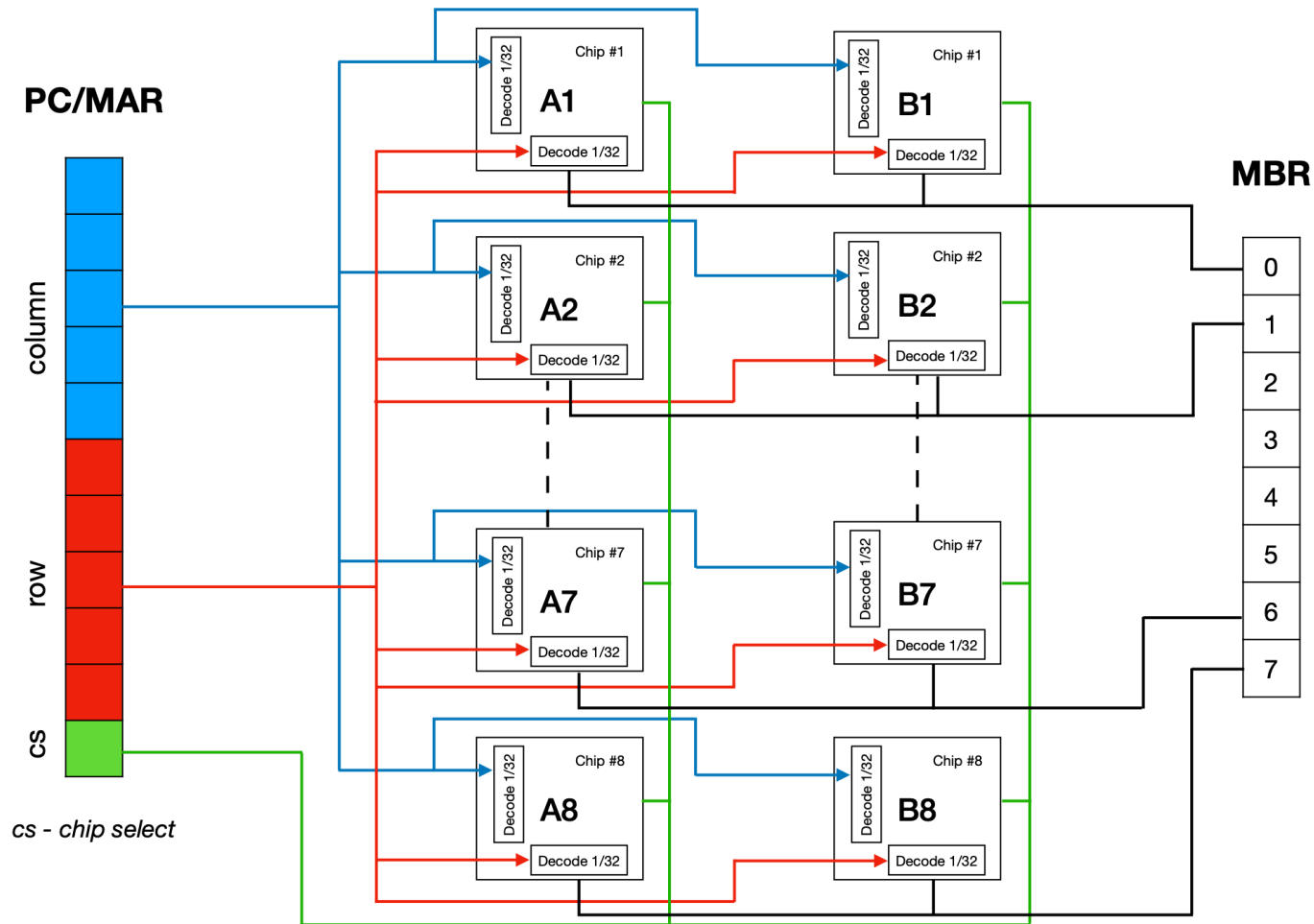


New RAM Technology (3)

- Foreground reading
- Check out any other RAM you can find
- See Web site:
 - The RAM Guide

TRACS Memory Organization (RAM)

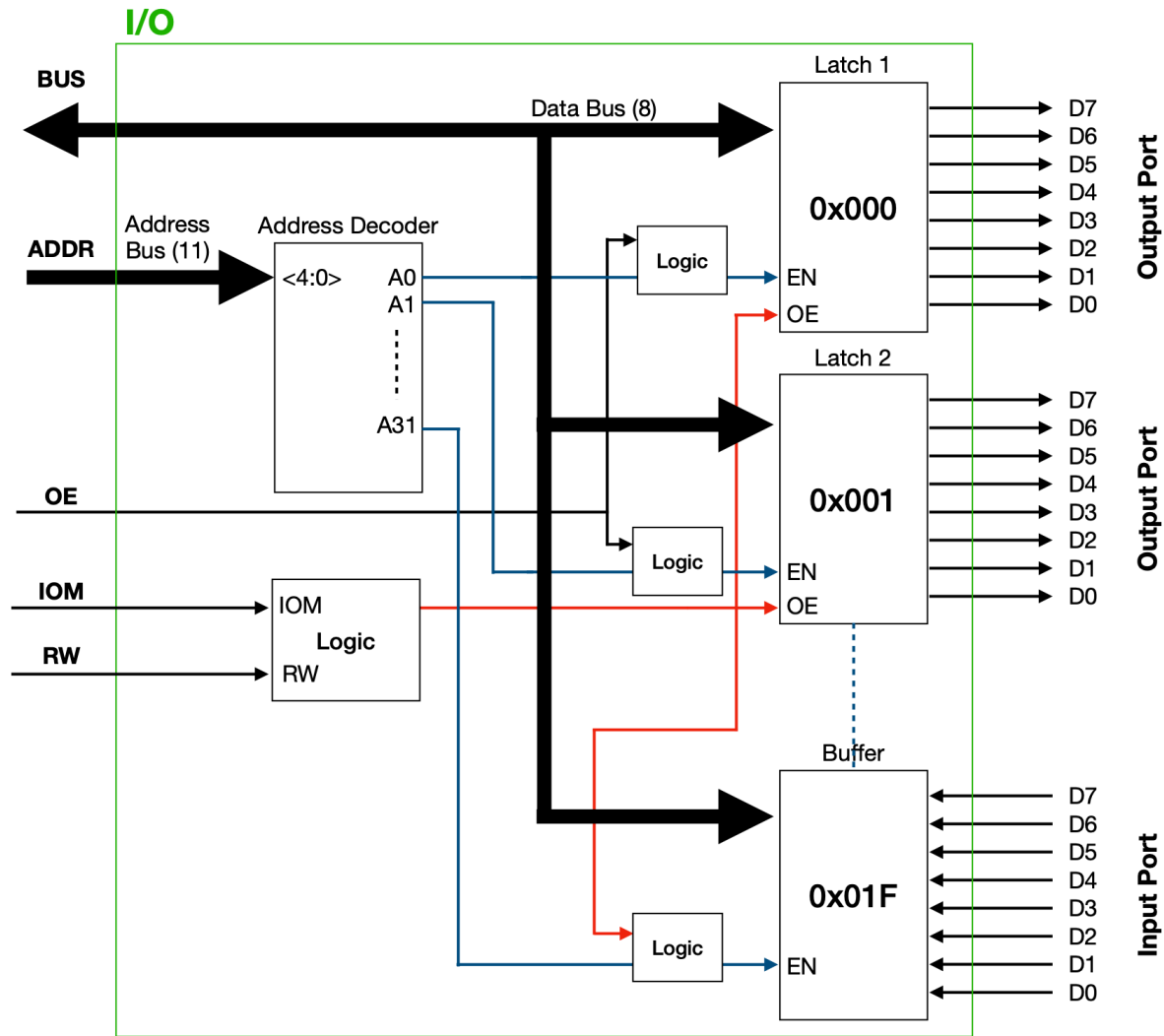
- Composed of **sixteen (16) 32x32 bit chips** for total of **16Kbit**
- **Two (2) chip groups A & B**
- Organized into (32 + 32) bit columns and (32 x 8) rows
- **Chip Select (cs)** identify the chip group A or B
- **Address bus** is composed of *column address*, *row address* and *chip group selector*



TRACS Memory Organization

TRACS Memory Organization (I/O)

- Isolated from Main Memory (as I/O Memory)
- **Maximum of 32 addressable latch/buffer**
- **IO address decoding**, enables the proper latch or buffer
- **Latches for output signals** and **buffer for input signals**
- **I/O read and write control** via IOM and RW control lines
- **Data latched (output)** when IOM=0 and RW=1
- **Data buffered (input)** when IOM=0 and RW=0



TRACS I/O Memory Organization



CpE 3202
Computer Organization & Architecture

End of Lecture

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References:

- Brey, Barry B. *The Intel microprocessors 8086/8088, 80186/80188, 80286, 80386, 80486, Pentium, Pentium Pro processor, Pentium II, Pentium III, Pentium 4, and Core2 with 64-bit extensions: architecture, programming, and interfacing* / Barry B. Brey—8th ed.
- Stallings, W. *Computer Organization and Architecture*, 6th edition, Pearson Education, Inc. (2003).